

MAINTENANCE MANUAL
800 MHz, 30-WATT TRANSMITTER/RECEIVER FRAME ASSEMBLY
19D900742G2, G3

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DESCRIPTION

The Transmitter/Receiver Frame Assembly contains the transmitter/receiver board, fixed tuned power amplifier section and power control circuit. Component parts for the exciter are located on the synthesizer/interconnect board and the transmitter/receiver board. The frequency synthesizer and frequency injection chain including a frequency tripler are located on the synthesizer/interconnect board. The transmitter/receiver board is mounted on the bottom side of the "H" frame chassis.

The exciter provides approximately 250 milliwatts of modulated RF power to the PA section which provides 30 watts power output. Figure 1 is a block diagram of the Century II radio showing both the transmitter and receiver.

TRANSMITTER

EXCITER

The synthesized frequency output and the injection output from the interconnect/frequency synthesizer board are applied to the balanced mixer through J101 and J102. The mixer output signal is the sum of these two input signals and will fall within the range of 408-410.5 MHz. The output of the balanced mixer is coupled through three tuned circuits (L101, L102, L103) to the base of amplifier Q101. Metering test point TP101 is used in tuning L101, L102 and L103. The typical DC reading is 5.6 volts.

CIRCUIT ANALYSIS

Following amplifier Q101 is frequency doubler Q102. The output of Q102

(816-821 MHz) is filtered by L107, L108 and L109, and are tuned to the operating frequency. The filter output is applied to the base of amplifier Q103.

The collector output of Q103 is applied to a power splitter consisting of L111 and C116, and L112 and C121. The portion of the RF signal coupled through L111 and C116 is applied to the base of amplifier Q104. The output of Q104 is coupled to the receiver and used as the 1st oscillator injection frequency. The signal coupled through L112 and C121 is applied to the base of exciter amplifier Q105. The collector tank of Q105 is tuned by C125 and C127.

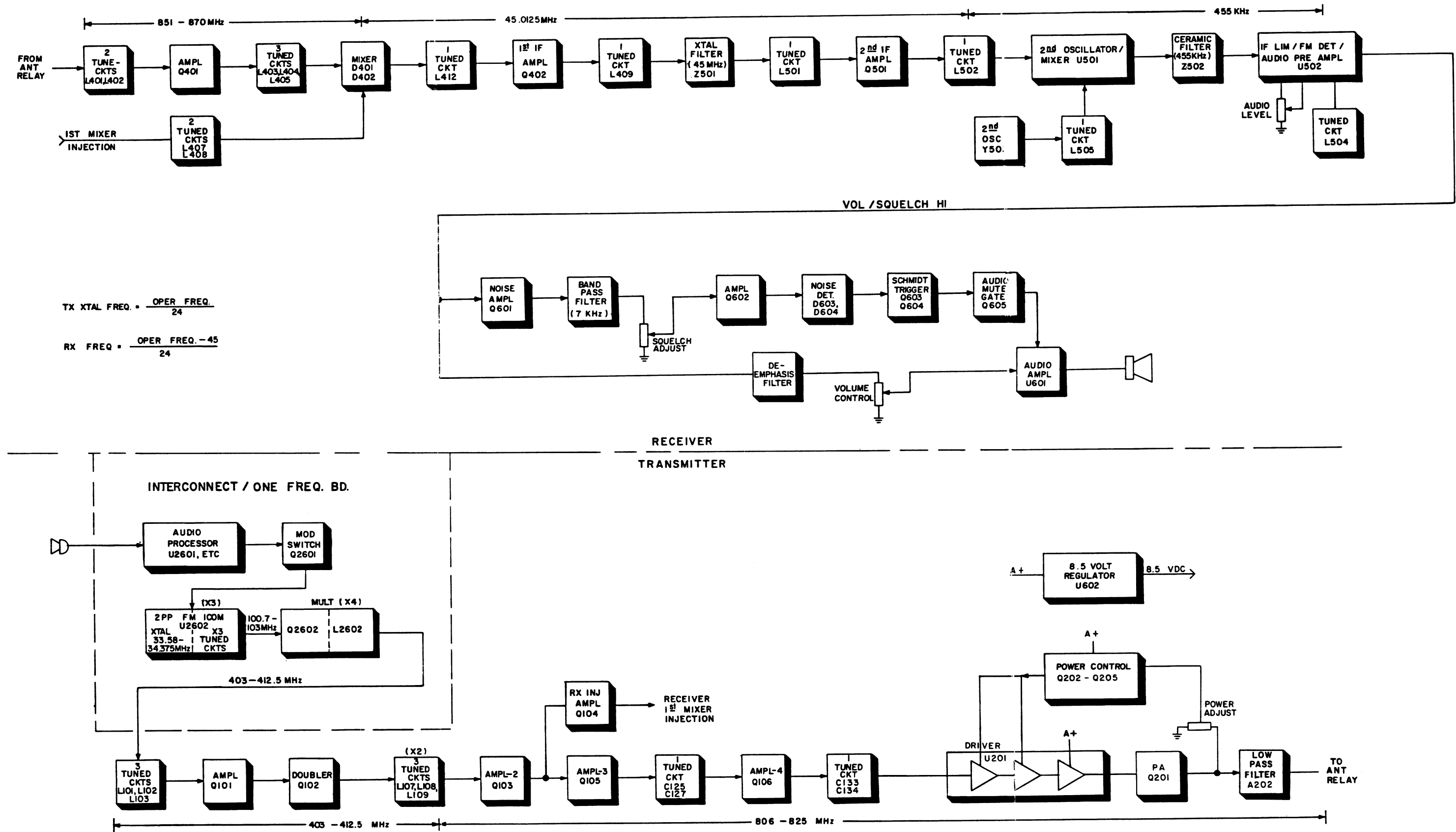
Following Q105 is amplifier Q106. The output of Q106 is tuned by C133 and C134.

Variable capacitors C125, C127, C133 and C134 are tuned for a maximum DC voltage reading at TP103. The typical DC reading at TP103 is 1.2 volts. Part of the RF signal at W102 is rectified by "sniffer" diode D101 to provide the voltage reading at TP103.

W102 is a 50 ohm stripline on the printed circuit board that connects to A201. Stripline W1 on A201 connects the exciter output to the driver amplifier.

POWER AMPLIFIER

The power amplifier consists of driver amplifier module U201, P.A. transistor Q201 and matching circuits. The driver amplifier amplifies the 250 milliwatt exciter output to provide drive for Q201. L201, C207, C208, C209, and L203 match the 50 ohm output impedance of U201 to the input impedance of Q201. L202 provides an isolated DC return for the emitter. L203 and L204 are the inductance of the leads of Q201. The output of Q201 is transformed to 50 ohms by L204, C210, C211, L205, and C212. L206



RC4366

Figure 1 - Transmitter/Receiver Block Diagram

provides an isolated DC feed path to the collector and C213 blocks D.C. from the output circuit. Stripline W207 connects the output to low pass filter A202. The filter output is applied to antenna relay K601.

RF POWER CONTROL CIRCUITS

Power adjustments is accomplished by controlling the DC collector voltage to the first and second stages of U201 by pass transistor Q205. Q205 is controlled by a feedback loop consisting of W206, D201, Q202, Q203, and Q204. The power is set by R203.

Any change in output power is sensed by the power control circuit. For example; if the output power increases, more RF is rectified by D201, increasing the base voltage of Q202. This causes Q202 to conduct more, reducing its collector voltage (and base voltage to Q203).

Reducing the base voltage applied to Q203 causes it to conduct less, raising the base voltage of PNP transistor Q204. With Q204 conducting less, there is less base voltage applied to pass transistor Q205 resulting in less collector voltage being applied to the first and second stages in U201. This reduces the output power of the PA module in proportion to the increase in output power detected by the base of Q202.

To protect Q201 against badly mismatched loads, a reverse (reflected) power detector consisting of W205, D203 and control R212 detects reverse power. When sufficient power is reflected to create enough voltage at R212, D204 conducts and reduces voltage from the pass transistor Q205 which reduces the drive to Q201, protecting it.

CAUTION

R212 is preset at the factory and normally does not require adjustment.

RECEIVER

Century II 800 MHz receivers are dual conversion, superheterodyne FM receivers designed for operation in the 861-865 MHz frequency range. A regulated 8.5 volts is used for all receiver stages except for the audio PA IC, which operates from the A+ supply.

The receiver uses intermediate frequencies of 45.0125 MHz and 455 kHz.

Adjacent channel selectivity is obtained by using two bandpass filters: a 45.0125 MHz crystal filter and a 455 kHz ceramic filter.

All receiver circuitry is mounted on the transmitter/receiver (Tx/Rx) board. The receiver consists of:

- Receiver Front End and 1st Mixer
- 45.0125 MHz 1st IF circuitry
- 2nd Oscillator
- 455 kHz 2nd IF circuitry with FM Detector
- Audio PA Circuit
- Squelch Circuit

RECEIVER FRONT END

RF from the antenna is coupled through two helical resonators (L401 and L402) to the base of RF amplifier Q401. Q401 is a class A, common emitter amplifier that provides a gain of approximately 8 to 10 dB. The amplified output is coupled through three additional helicals to the 1st mixer. The five helicals provide the front end selectivity.

1ST MIXER

The 1st mixer is a dual balanced diode mixer that converts a signal in the 861-865 MHz range to the 45.0125 MHz 1st IF frequency.

RF from the front end helicals is coupled through C404 to mixer diodes D401 and D402. The low side injection input from the exciter is coupled through two helicals (L407 and L408) to the mixer diodes. The injection input port is isolated from the RF input and IF output by a balancing transformer consisting of L413 tapped to ground.

The 1st mixer output is coupled through a tuned circuit (L412 and C405) that matches the mixer output to gate 1 of 1st IF amplifier Q402.

TP401 is used in tuning the discrete IF stages and the injection filter, L408 and L409.

1ST IF AMPLIFIER AND FILTER

IF Amplifier Q402 is a dual gate FET that provides good intermodulation and desensitization characteristics. The amplifier also acts as a buffer between

the variable balanced mixer output impedance and the crystal filter.

The IF output signal at the drain of Q402 is coupled through a tuned circuit (L409 and C408) that sets the impedance to crystal filter Z501.

Z501 is a 45.0125 MHz, four-pole crystal filter that provides a minimum of 30 dB adjacent channel rejection. The filter output is applied through a tuned circuit (L501, C501 and C526) that matches the output impedance of Z501 to the second IF amplifier.

2ND IF AMPL

2nd IF Amplifier Q501 is a dual-gate FET. The filter output is applied to Gate 1 of the amplifier, and the output is taken from the drain. The biasing on Gate 2 and the drain load determines the gain of the stage. The amplifier provides approximately 20 dB of IF gain. The output of Q501 is coupled through L502 which matches the amplifier output to the input of IC U501.

2ND OSC/MIXER AND IF AMPL

The 2nd oscillator, mixer and 3rd IF amplifier consists of U501 and associated circuitry. The oscillator operates at 45.4675 MHz. The oscillator crystal is Y501. The 45.0125 MHz input frequency is mixed with the oscillator frequency to provide the 2nd IF frequency of 455 kHz. Diodes D501 and D502 limit the mixer output. L503 is tuned for the 2nd IF output of 455 kHz.

FILTER, LIMITER AND DETECTOR

The output of U501 is coupled through ceramic filter Z502 which provides the 455 kHz selectivity, and applied to U502. Test Point TP501 is used in aligning the receiver, and can be used to check the output of U501. The typical DC reading at TP501 is 2.7 volts.

U502 and associated circuitry consists of a 455 kHz limiter, a

quadrature-type FM detector and an audio pre-amplifier. L504 is the quadrature detector coil. Audio Level Potentiometer R521 is used to set the audio output level to the audio amplifier.

AUDIO CIRCUITS

Audio from the audio pre-amplifier U502 is applied to the voice/tone reject filter in the logic board through J903-3 and J2502-3 on the synthesizer/interconnect board. The voice/tone reject filter removes the busy tone and applies the received audio to the alert tone switch. The alert tone switch under control of the microprocessor selects either alert tones or voice frequencies to apply to the audio mute switch. The audio mute switch, under control of the microprocessor completes the audio path to the de-emphasis network.

On GE-MARC V CORONA, CENTURA TC and CENTURA trunked mobile radios, the audio passes through the de-emphasis network (R901 on the interconnect board, R629, C607 and C608) to volume control R630.

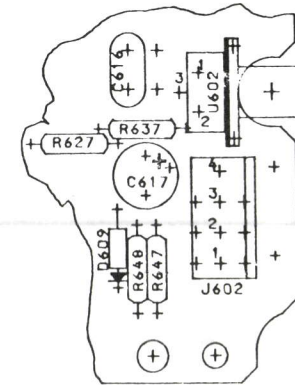
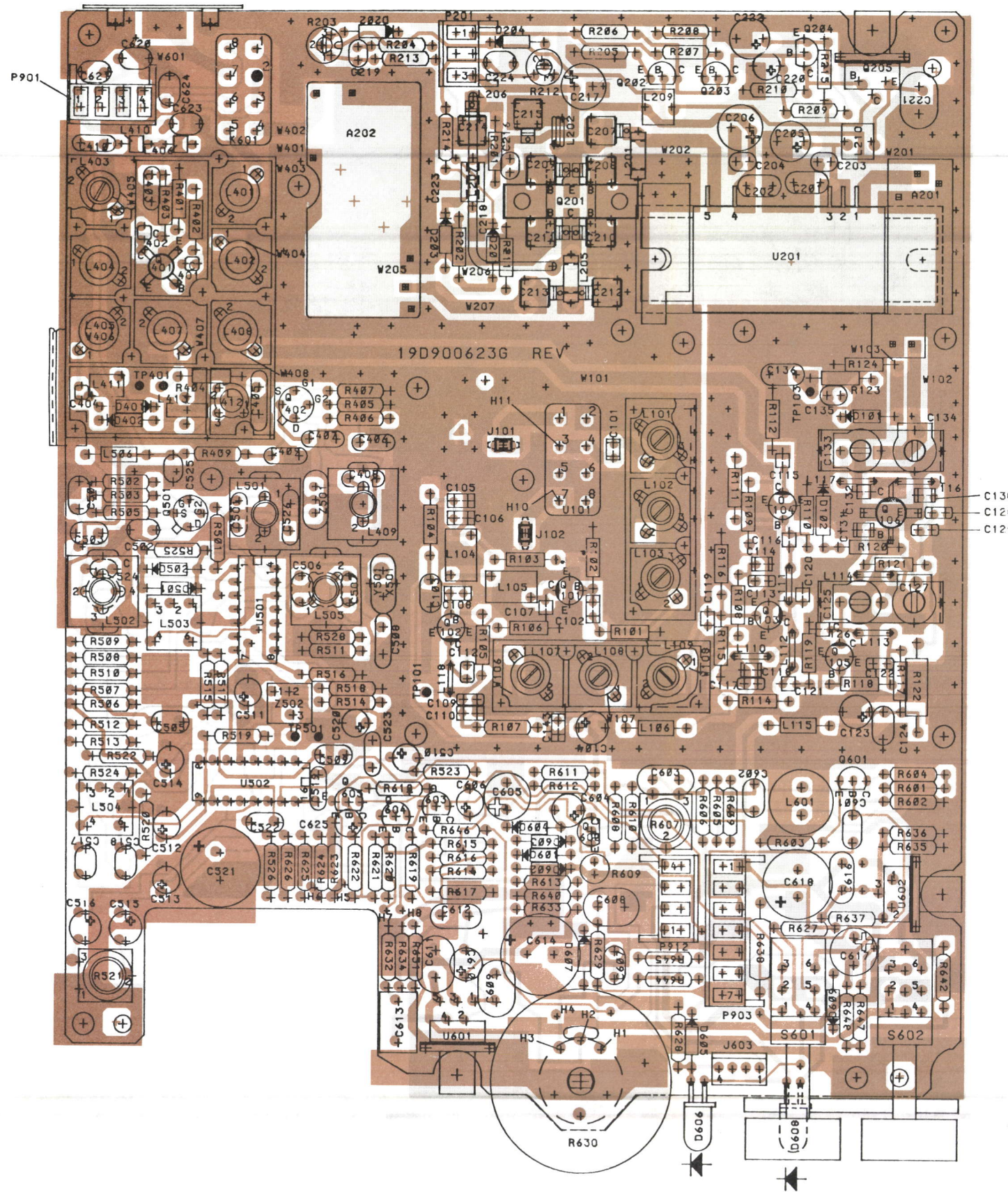
On GE-MARC V Classic radios the audio from the audio/mute select switch is applied to the electronic audio attenuator. The electronic audio attenuator under control of the microprocessor controls the audio level applied to the audio amplifier and replaces the volume control potentiometer found in the GE-MARC V CORONA, CENTURA TC, and CENTURA radios. Audio from the electronic attenuator is applied to the audio amplifier through the de-emphasis network.

The audio amplifier IC (U601) drives the speaker (or handset) at the desired audio level. The feedback loop containing R633, R634, and C610 determines the amplifiers closed loop gain. R631 and C612 provide the high audio frequency roll-off above 6 kHz.

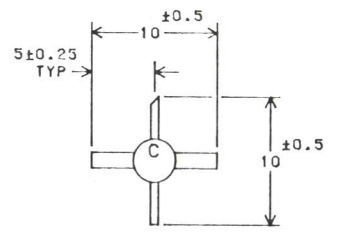
Rx Mute Gate (Q605), under control of the Rx MUTE signal, controls the audio amplifier. When Rx MUTE is high, Q605 is turned off. This turns on U601, allowing audio to be heard over the speaker.

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WORLD HEADQUARTERS • LYNCHBURG, VIRGINIA 24502 U.S.A.

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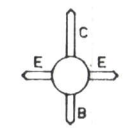


GROUP 3 ONLY
DETAIL B



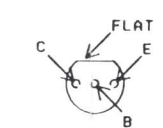
LEAD TRIMMING
FOR Q106

LEAD IDENTIFICATION
FOR Q101-Q105 & Q401



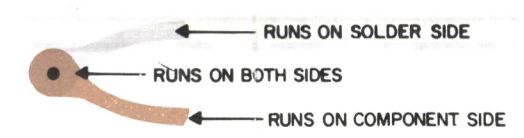
TOP VIEW

LEAD IDENTIFICATION FOR
Q401, Q402, Q603, Q604 & Q605
Q202, Q203, Q204

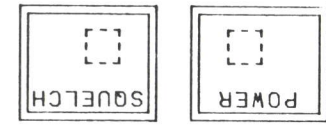


IN-LINE
TOP VIEW

NOTE:
CASE SHAPE IS DETERMINING
FACTOR FOR LEAD IDENTIFICATION.



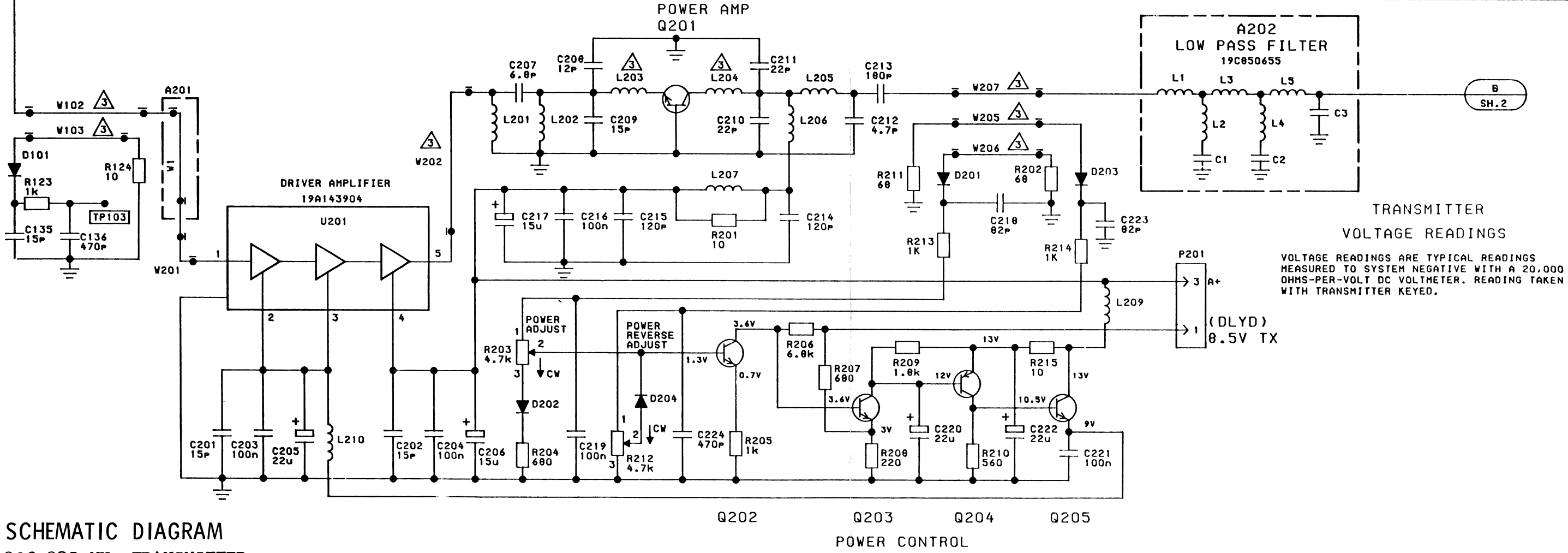
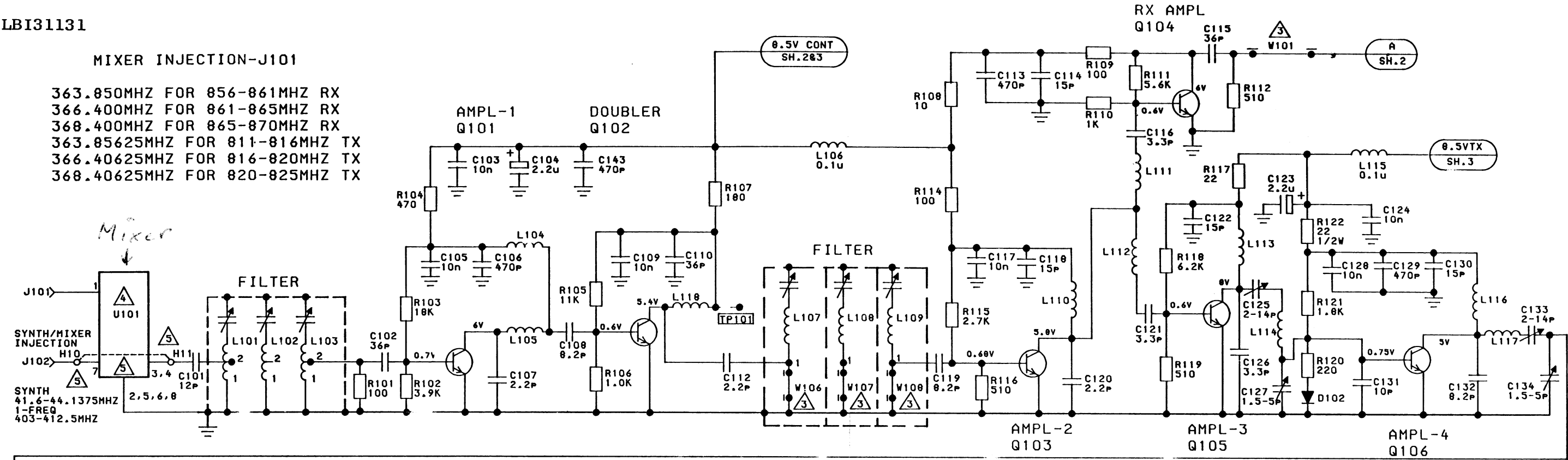
(19D900624, Rev. 7)
(19A702341, Sh. 1, Rev. 4)
(19A702341, Sh. 2, Rev. 4)



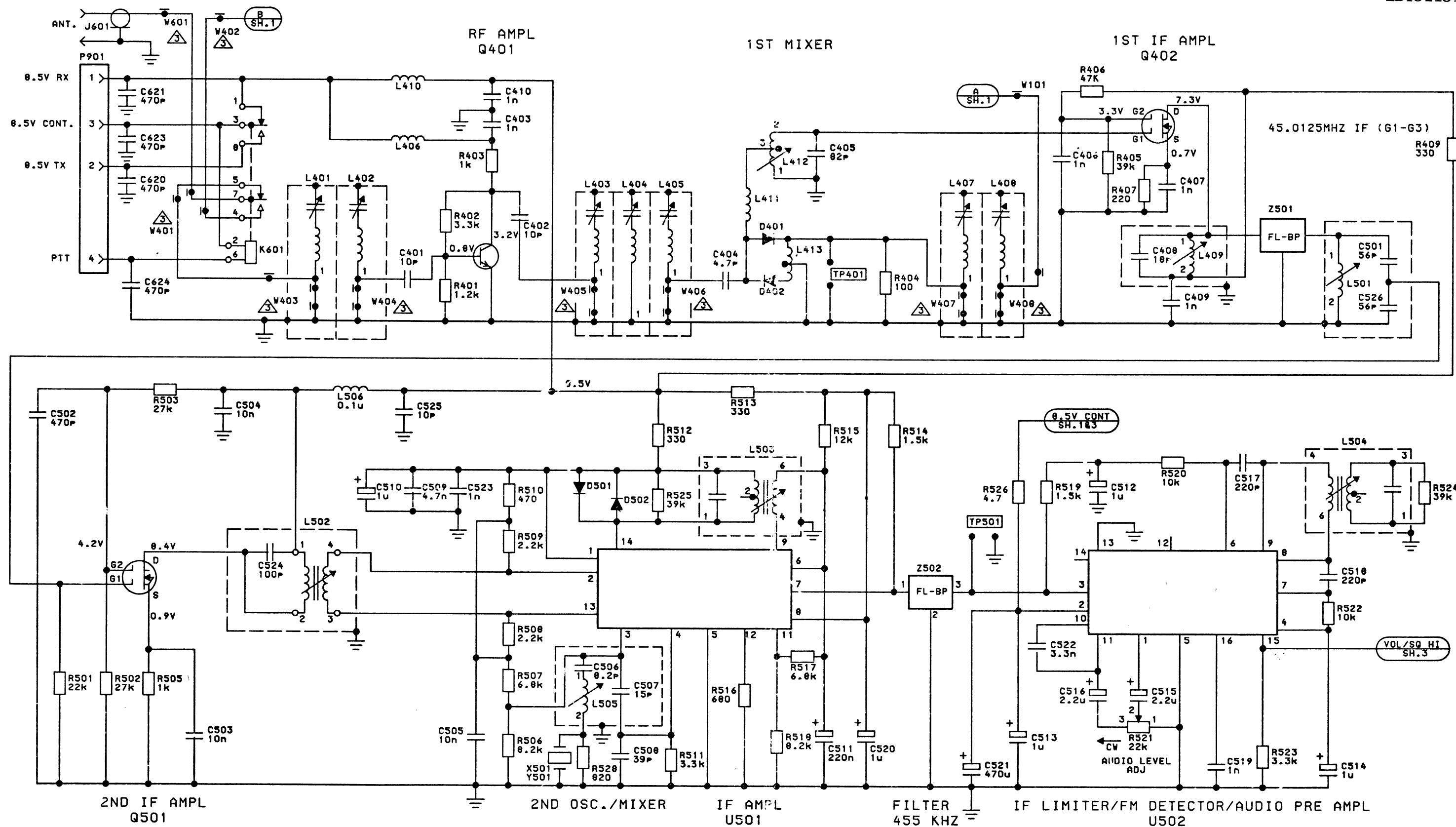
OUTLINE DIAGRAM

TRANSMITTER/RECEIVER BOARD

Issue 3



SCHEMATIC DIAGRAM
806-825 MHz TRANSMITTER
19D900742G2 & G3

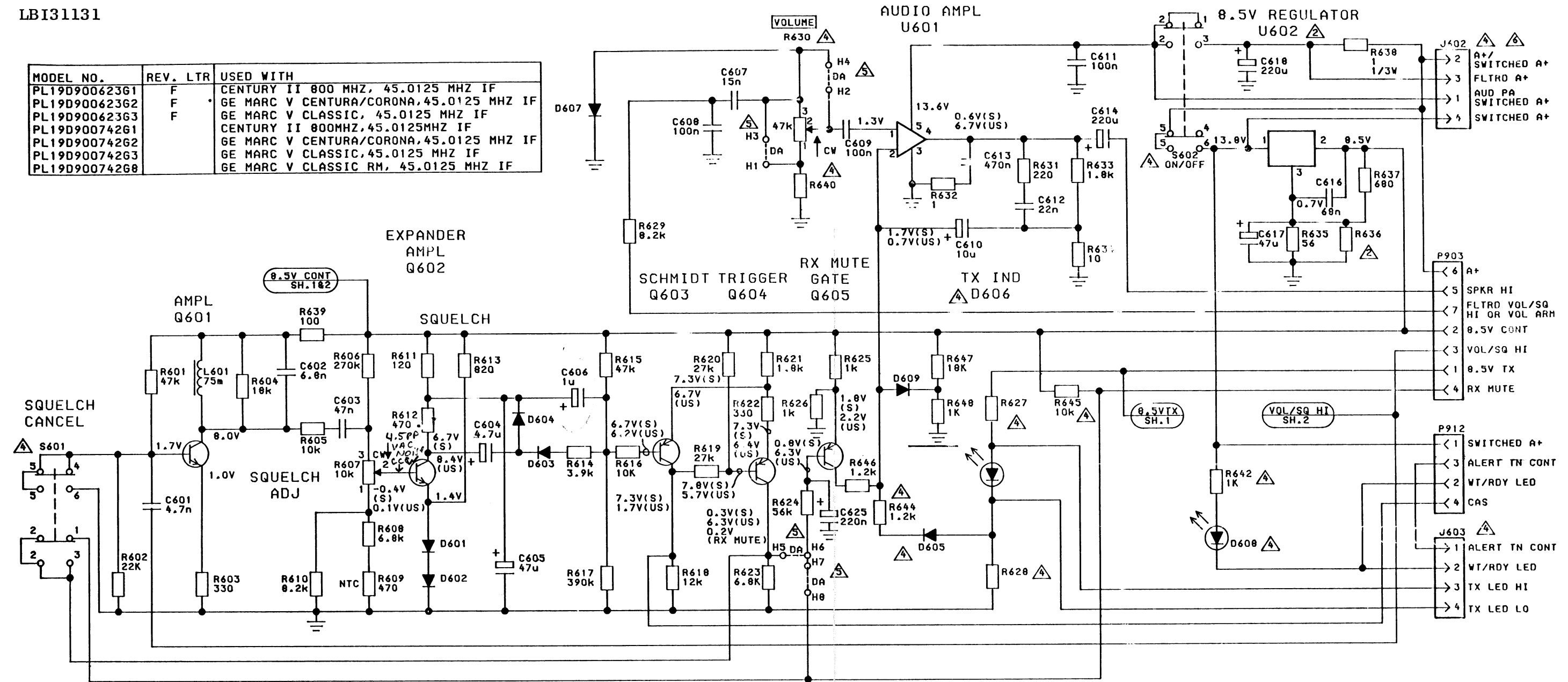


SCHEMATIC DIAGRAM

851-870 MHz RECEIVER

19D900742G2 & G3

MODEL NO.	REV. LTR	USED WITH
PL19D900623G1	F	CENTURY II 800 MHZ, 45.0125 MHZ IF
PL19D900623G2	F	GE MARC V CENTURA/CORONA, 45.0125 MHZ IF
PL19D900623G3	F	GE MARC V CLASSIC, 45.0125 MHZ IF
PL19D900742G1		CENTURY II 800MHZ, 45.0125MHZ IF
PL19D900742G2		GE MARC V CENTURA/CORONA, 45.0125 MHZ IF
PL19D900742G3		GE MARC V CLASSIC, 45.0125 MHZ IF
PL19D900742G8		GE MARC V CLASSIC RM, 45.0125 MHZ IF



NOTES:
2 VALUE OF R636 DEPENDS ON COLOR CODE ON U602.

U602 COLOR CODE	R636 VALUE Ω
BROWN	OMIT R636
RED	270
ORANGE	100
YELLOW	47
GREEN	22
BLUE	6.8

3 PART OF PRINTED CIRCUIT BOARD.

SCHEMATIC DIAGRAM
RECEIVER AUDIO
19D900742G2 & G3

4 COMPONENT VALUES

61 800MHZ 1 FREQ	62 GE MARC V CENTURA/CORONA	63 GE MARC V CLASSIC
D605	OMIT	OMIT
D606	D606	OMIT
OMIT	D608	OMIT
OMIT	J101	J101
OMIT	OMIT	J602
OMIT	OMIT	J603
R627A 220	R627A 220	R627B 150
R628A 150	R628A 150	R628B 180
R630	R630	OMIT
R640A 10	R640B 2.2K	R640C 47K
OMIT	R642	OMIT
S601	OMIT	OMIT
S602	S602	OMIT
OMIT	U101	U101
R644	OMIT	OMIT
OMIT	R645	R645

5 DA JUMPER PRESENT H5 TO H6 IN G1 ONLY.
DA JUMPER PRESENT H7 TO H8 IN G2,G3,ONLY.
DA JUMPER PRESENT H10 TO H11 IN G1 ONLY.
DA JUMPER PRESENT H1 TO H3,H2 TO H4 IN G3 ONLY.

ALL RESISTORS ARE 1/4 WATT UNLESS OTHERWISE SPECIFIED.
RESISTOR VALUES IN Ω UNLESS FOLLOWED BY MULTIPLIER K OR M.
CAPACITOR VALUES IN F UNLESS FOLLOWED BY MULTIPLIER μ , n OR p.
INDUCTANCE VALUES IN H UNLESS FOLLOWED BY MULTIPLIER m OR u.

RECEIVER
VOLTAGE READINGS

VOLTAGE READINGS ARE TYPICAL READINGS MEASURED TO SYSTEM NEGATIVE WITH A 20,000 OHMS-PER VOLT DC VOLTMETER UNDER THE FOLLOWING CONDITIONS:

1. NO SIGNAL INPUT
2. VOLUME CONTROL (R630) SET TO MINIMUM
3. SQUELCH CANCEL (S601) SWITCHED OFF
4. UNSQUELCHED (US)-SQUELCH ADJUST (R607) SET TO MINIMUM (CW)
5. SQUELCHED (S)-SQUELCH ADJUST (R607) SET TO MAXIMUM (CCW)

6 FOR TRUNK MOUNT RADIO, J602 IS SWITCHED A+ INPUT FROM CONTROL UNIT.

PARTS LIST

800 MHZ, 30 WATT
TRANSMIT/RECEIVE FRAME
19D900742G2 CORONA & CENTURA
19D900742G3 CLASSIC
ISSUE 3

SYMBOL	GE PART NO.	DESCRIPTION
A1		TRANSMIT/RECEIVE BOARD 19D900623G2 CORONA & CENTURA - REV F 19D900623G3 CLASSIC - REV F
A202	19C850655G1	Low Pass Filter. ----- CAPACITORS -----
C101	19A700219P30	Ceramic: 12 pF ±5%, 100 VDCW, temp coef 0 PPM.
C102	19A700219P48	Ceramic: 36 pF ±5%, 100 VDCW, temp coef 0 PPM.
C103	19A700234P7	Polyester: 0.01 uF ±10%, 50 VDCW.
C104	19A701534P5	Tantalum: 2.2 uF, ±20%, 35 VDCW.
C105	19A116192P1	Ceramic: 0.01 uF ±20%, 50 VDCW; sim to Erie 8121 SPECIAL.
C106	19A116192P2	Ceramic: 470 pF ±20%, 50 VDCW; sim to Erie 811-A050-W5R-471M.
C107	19A700219P10	Ceramic: 2.2 pF ±5%, 100 VDCW, temp coef 0 PPM.
C108	19A700219P24	Ceramic: 8.2 pF ±5%, 100 VDCW, temp coef 0 PPM.
C109	19A116192P1	Ceramic: 0.01 uF ±20%, 50 VDCW; sim to Erie 8121 SPECIAL.
C110	19A700219P48	Ceramic: 36 pF ±5%, 100 VDCW, temp coef 0 PPM.
C112	19A700219P10	Ceramic: 2.2 pF ±5%, 100 VDCW, temp coef 0 PPM.
C113	19A116192P2	Ceramic: 470 pF ±20%, 50 VDCW; sim to Erie 811-A050-W5R-471M.
C114	19A700219P33	Ceramic: 15 pF ±5%, 100 VDCW, temp coef 0 PPM.
C115	19A700219P48	Ceramic: 36 pF ±5%, 100 VDCW, temp coef 0 PPM.
C116	19A700219P14	Ceramic: 3.3 pF ±5%, 100 VDCW, temp coef 0 PPM.
C117	19A116192P1	Ceramic: 0.01 uF ±20%, 50 VDCW; sim to Erie 8121 SPECIAL.
C118	19A700219P33	Ceramic: 15 pF ±5%, 100 VDCW, temp coef 0 PPM.
C119	19A700219P24	Ceramic: 8.2 pF ±5%, 100 VDCW, temp coef 0 PPM.
C120	19A700219P10	Ceramic: 2.2 pF ±5%, 100 VDCW, temp coef 0 PPM.
C121	19A700219P14	Ceramic: 3.3 pF ±5%, 100 VDCW, temp coef 0 PPM.
C122	19A700219P33	Ceramic: 15 pF ±5%, 100 VDCW, temp coef 0 PPM.
C123	19A701534P5	Tantalum: 2.2 uF, ±20%, 35 VDCW.
C124	19A700234P7	Polyester: 0.01 uF ±10%, 50 VDCW.
C125	19A700008P2	Variable: 2.28 to 14.13 pF; sim to EF Johnson 187-0109-005.
C126	19A700219P14	Ceramic: 3.3 pF ±5%, 100 VDCW, temp coef 0 PPM.
C127	19A700008P3	Variable: 1.56 to 4.86 pF; sim to EF Johnson 187-0103-005.
C128	19A116192P1	Ceramic: 0.01 uF ±20%, 50 VDCW; sim to Erie 8121 SPECIAL.
C129	19A116192P2	Ceramic: 470 pF ±20%, 50 VDCW; sim to Erie 811-A050-W5R-471M.
C130	19A700219P33	Ceramic: 15 pF ±5%, 100 VDCW, temp coef 0 PPM.
C131	19A700219P26	Ceramic: 10 pF ±5%, 100 VDCW, temp coef 0 PPM.
C132	19A700219P24	Ceramic: 8.2 pF ±5%, 100 VDCW, temp coef 0 PPM.
C133	19A700008P2	Variable: 2.28 to 14.13 pF; sim to EF Johnson 187-0109-005.
C134	19A700008P3	Variable: 1.56 to 4.86 pF; sim to EF Johnson 187-0103-005.
C135	19A700219P33	Ceramic: 15 pF ±5%, 100 VDCW, temp coef 0 PPM.
C136	19A701602P14	Ceramic: 470 pF ±10%, 1000 VDCW.
C143	19A116192P2	Ceramic: 470 pF ±20%, 50 VDCW; sim to Erie 811-A050-W5R-471M.

SYMBOL	GE PART NO.	DESCRIPTION
C201 and C202	19A701624P12	Ceramic, disc: 15 pF ±5%, 500 VDCW, temp coef 0 PPM.
C203 and C204	19A143565P8	Ceramic: 0.1 uF ±10%, 50 VDCW.
C205	19A701534P8	Tantalum: 0.47 uF ±20%, 35 VDCW.
C206	19A701225P1	Electrolytic: 15 uF -10+75%, 63 VDCW; sim to Sprague 501D156-G025BB1C.
C206		
C207	19A700006P3	Mica: 5.6 pF ±10%, 250 VDCW; sim to Underwood 3HS0020.
C212	19A700006P1	Mica: 4.7 pF ±10%, 250 VDCW; sim to Underwood 3HS0020.
C213	19A700006P41	Mica: 180 pF ±5%, 250 VDCW; sim to Underwood 3HS0020.
C214 and C215	19A700006P36	Mica: 120 pF ±5%, 250 VDCW; sim to Underwood 3HS0020.
C216	19A143565P8	Ceramic: 0.1 uF ±10%, 50 VDCW.
C217	19A701225P1	Electrolytic: 15 uF -10 +75%, 63 VDCW; sim to Sprague 501D156-G025BB1C.
C218	19A134418P35	Ceramic: 82 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM.
C219	19A143565P8	Ceramic: 0.1 uF ±10%, 50 VDCW.
C220	19A701534P8	Tantalum: 0.47 uF ±20%, 35 VDCW.
C221	19A700234P13	Polyester: 0.1 uF ±10%, 50 VDCW.
C222	19A701534P4	Tantalum: 1 uF ±20%, 35 VDCW.
C223	19A134418P35	Ceramic: 82 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM.
C224	19A700233P5	Ceramic: 470 pF ±20%, 50 VDCW.
C401 and C402	19A700219P26	Ceramic: 10 pF ±5%, 100 VDCW, temp coef 0 PPM.
C403	19A700233P7	Ceramic: 1000 pF ±20%, 50 VDCW.
C404	19A700219P18	Ceramic: 4.7 pF ±5%, 100 VDCW, temp coef 0 PPM.
C405	19A700235P24	Ceramic: 82 pF ±5%, 50 VDCW.
C406 and C407	19A700233P7	Ceramic: 1000 pF ±20%, 50 VDCW.
C408	19A700235P16	Ceramic: 18 pF ±5%, 50 VDCW.
C409 and C410	19A700233P7	Ceramic: 1000 pF ±20%, 50 VDCW.
C501	19A700235P22	Ceramic: 56 pF ±5%, 50 VDCW.
C502	19A700233P5	Ceramic: 470 pF ±20%, 50 VDCW.
C503 thru C505	19A700234P7	Polyester: 0.01 uF ±10%, 50 VDCW.
C506	19A700235P12	Ceramic: 8.2 pF ±0.25 pF, 50 VDCW.
C507	19A700235P15	Ceramic: 15 pF ±5%, 50 VDCW.
C508	19A700235P20	Ceramic: 39 pF ±5%, 50 VDCW.
C509	19A700234P5	Polyester: 4700 pF ±10%, 50 VDCW.
C510	19A701534P4	Tantalum: 1 uF ±20%, 35 VDCW.
C511	19A701534P2	Tantalum: 0.22 uF ±20%, 35 VDCW.
C512 thru C514	19A701534P4	Tantalum: 1 uF ±20%, 35 VDCW.
C515 and C516	19A701534P5	Tantalum: 2.2 uF, ±20%, 35 VDCW.
C517 and C518	19A700233P3	Ceramic: 220 pF ±10%, 50 VDCW.
C519	19A700233P7	Ceramic: 1000 pF ±20%, 50 VDCW.
C520	19A701534P4	Tantalum: 1 uF ±20%, 35 VDCW.
C521	19A134730P3	Electrolytic: 470 uF +100 -10%, 16 VDCW.
C522	19A700234P4	Polyester: 3300 pF ±10%, 50 VDCW.

SYMBOL	GE PART NO.	DESCRIPTION
C523	19A700233P7	Ceramic: 1000 pF ±20%, 50 VDCW.
C524	19A700002P25	Ceramic disc: 100 pF ±5%, 50 VDCW; temp coef -150 +60 PPM.
C525	19A700235P13	Ceramic: 10 pF ±5%, 50 VDCW.
C526	19A700235P22	Ceramic: 56 pF ±5%, 50 VDCW.
C601	19A700234P5	Polyester: 4700 pF ±10%, 50 VDCW.
C602	19A700234P6	Polyester: 6800 pF ±10%, 50 VDCW.
C603	19A700234P11	Polyester: 0.047 uF ±10%, 50 VDCW.
C604	19A701534P6	Tantalum: 4.7 uF ±20%, 35 VDCW.
C605	19A134730P1	Electrolytic: 47 uF +100 -10%, 16 VDCW.
C606	19A701534P4	Tantalum: 1 uF ±20%, 35 VDCW.
C607	19A700234P8	Polyester: .015 uF ±10%, 50 VDCW; sim to NISSEI AMXV or AMZW.
C608 and C609	19A700234P13	Polyester: 0.1 uF ±10%, 50 VDCW.
C610	19A701534P7	Tantalum: 10 uF ±20%, 16 VDCW.
C611	19A700234P13	Polyester: 0.1 uF ±10%, 50 VDCW.
C612	19A700234P9	Polyester: 0.22 uF ±10%, 50 VDCW.
C613	19A700004P6	Metalized Polyester: 0.47 ±10%, 63 VDCW.
C614	19A134730P2	Electrolytic: 220 uF +100 -10%, 25 VDCW.
C616	19A700234P12	Polyester: 0.068 uF ±10%, 50 VDCW.
C617	19A134730P1	Electrolytic: 47 uF +100 -10%, 16 VDCW.
C618	19A134730P2	Electrolytic: 220 uF +100 -10%, 25 VDCW.
C620 and C621	19A700233P5	Ceramic: 470 pF ±20%, 50 VDCW.
C623 and C624	19A700233P5	Ceramic: 470 pF ±20%, 50 VDCW.
C625	19A701534P2	Tantalum: 0.22 uF ±20%, 35 VDCW.
D101	19A700047P1	Silicon, 100 mW continous dissipation.
D102	19A115100P1	Silicon; sim to Type 1N458A.
D201	19A700047P2	Silicon.
D202	19A702015P1	Silicon; sim to 1N458A.
D203	19A700047P3	Silicon: 100 mW; sim to 1N6263.
D204	19A702015P1	Silicon; sim to 1N458A.
D401	19A116052P4	Silicon, hot carrier: Fwd. drop .350 volts max.
D501 and D502	19A700028P1	Silicon, fast recovery: fwd current 75 mA, 75 PIV; sim to Type 1N4148.
D601 thru D604	19A700028P1	Silicon, fast recovery: fwd current 75 mA, 75 PIV; sim to Type 1N4148.
D606	19A134738P1	Diode, optoelectronic: red; sim to Siemens LD41/11.
D607	19A700028P1	Silicon, fast recovery: fwd current 75 mA, 75 PIV; sim to Type 1N4148.
D608	19A134354P3	Optoelectronic: green; sim to Hew. Packard 5082-4955.
D609	19A700028P1	Silicon, fast recovery: fwd current 75 mA, 75 PIV; sim to Type 1N4148.
J101	19A701883P4	Contact, electrical; sim to AMP 86444-1.
J102	19A701883P4	Contact, electrical; sim to AMP 86444-1.
J602	19A116659P103	Connector, printed wiring: 4 contacts rated at 5 amps; sim to Molex 09-60-1041.
J603	19A700072P30	Printed wire: 4 contacts rated at 2.5 amps; sim to Molex 22-27-2041.
K601	19A700061P1	Hermetic sealed: 180 to 341 ohms coil res, 8-16.3 VDC; sim to GE 3SAV1760A2, CPClare HPW-1201558, or Potter-Brumfield HCM6160.

SYMBOL	GE PART NO.	DESCRIPTION
		----- INDUCTORS -----
L101 thru L103	19J706154P10	RF Coil: sim to Paul Smith SK802-1.
L104	19J706085P4	Coil, RF: 0.065 uH ind., ±5%; sim to Paul Smith LM-2.
L105	19J706085P8	Coil, RF: 0.110 uH ind., ±5%; sim to Paul Smith LM-2.
L106	19A700024P1	Coil, RF: 100 nH ±10%, 0.08 ohms DC res max, 100 v.
L107 thru L109	19B233593P4	Coil, RF: sim to Paul Smith SK-832-1.
L110	19A701524P1	Coil.
L111	19A701524P5	Coil.
L112	19A701524P2	Coil.
L113	19A701524P3	Coil.
L114	19A701524P1	Coil.
L115	19A700024P1	Coil, RF: 100 nH ±10%, 0.08 ohms DC res max, 100 v.
L116	19A701524P4	Coil.
L117	19A701524P1	Coil.
L118	19A702028P2	Coil.
L201	19A701006P6	Strap.
L202	19A138196P4	Coil.
L203 and L204		Part of printed board.
L205	19A701006P4	Strap.
L206	19A702463P1	Coil.
L207	19A701091G1	Coil.
L209 and L210	19A138298P1	Coil.
L401 and L402	19B233593P2	Coil, RF: sim to Paul Smith SK-832-1.
L403	19B233593P1	Coil, RF: sim to Paul Smith SK-832-1.
L404	19B233593P2	Coil, RF: sim to Paul Smith SK-832-1.
L405	19B233593P1	Coil, RF: sim to Paul Smith SK-832-1.
L406	19A138400G1	Coil.
L407 and L408	19B233593P3	Coil, RF: sim to Paul Smith SK-832-1.
L409	19A134729P4	Coil, RF: sim to Paul Smith SK-832-1.
L410	19A138400G1	Coil.
L411	19A136535P1	Coil.
L412	19J706083P23	Coil, RF: variable.
L413	19A701768G1	Coil.
L501	19A134729P4	Coil, RF: sim to Paul Smith SK-832-1.
L502	19B800691P1	Coil, RF: single pole, wire size No. 24 AWG.
L503 and L504	19A134747P1	Transformer, IF: 455 KHz.
L505	19J706029P4	RF Coil, variable; sim to Paul Smith EF 223.
L506	19A700024P1	Coil, RF: 100 nH ±10%, 0.08 ohms DC res max, 100 v.
L601	19A702322P1	Reactor, audio freq: 75 MHz ±10%; sim to Festinduktiviteten DR 270/5-CL.
P201	19A116659P1	Connector, printed wiring: 3 contacts rated at 5 amps; sim to Molex 09-52-3032.
P901	19A116659P15	Connector, printed wiring: 4 contacts rated at 5 amps; sim to Molex 09-52-3042.
		----- PLUGS -----

*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
P903	19A116659P83	Connector, printed wiring: 7 contacts rated at 5 amps; sim to Molex 09-52-3072 SPECIAL.	R213 and R214	19A700019P37	Deposited carbon: 1K ohms $\pm 5\%$, 1/4 w.	R617	19A700019P68	Deposited carbon: 0.39M ohms $\pm 5\%$, 1/4 w.	W106 thru W108		Part of printed board.		19A700034P3	Hexnut: M2.5--.45. (Secures Q205, U601, U602).
P912	19A116659P15	Connector, printed wiring: 4 contacts rated at 5 amps; sim to Molex 09-52-3042.	R215	19A700106P15	Composition: 10 ohms $\pm 5\%$, 1/4 w.	R618	19A700019P50	Deposited carbon: 12K ohms $\pm 5\%$, 1/4 w.			Part of printed board.		19A701312P4	Flatwasher: M2.5. (Secures Q205 & U602).
		----- TRANSISTORS -----	R401	19A700106P65	Composition: 1.2K ohms $\pm 5\%$, 1/4 w.	R619 and R620	19A700019P54	Deposited carbon: 27K ohms $\pm 5\%$, 1/4 w.	W201 and W202		Part of printed board.		19A700032P3	Lockwasher, tooth, steel, metric: 2.5. (Secures Q205, U601, U602).
Q101 thru Q105	19A702062P1	Silicon, NPN.	R402	19A700106P75	Composition: 3.3K ohms $\pm 5\%$, 1/4 w.	R621	19A700019P40	Deposited carbon: 1.8K ohms $\pm 5\%$, 1/4 w.	W205 thru W207		Part of printed board.		19C328587P1	Pushbutton. (Used with S601 & S602).
Q106	19A134697P1	Silicon, NPN.	R403	19A700106P63	Composition: 1K ohms $\pm 5\%$, 1/4 w.	R622	19A700019P31	Deposited carbon: 330 ohms $\pm 5\%$, 1/4 w.			Part of printed board.		19A138451P1	Tuning slug. (Used with L101-L103, L107-L109).
Q202 and Q203	19A700023P1	Silicon, NPN; sim to Type 2N3904.	R404	19A700106P39	Composition: 100 ohms $\pm 5\%$, 1/4 w.	R623	19A700019P47	Deposited carbon: 6.8K ohms $\pm 5\%$, 1/4 w.	W401 thru W409		Part of printed board.		19A701886P1	Spring. (Used with L101-L103, L107-L109, L401-L407).
Q204	19A700022P1	Silicon, PNP; sim to Type 2N3906.	R405	19A700019P56	Deposited carbon: 39K ohms $\pm 5\%$, 1/4 w.	R624	19A700019P58	Deposited carbon: 56K ohms $\pm 5\%$, 1/4 w.	W601		Part of printed board.		19A701544P1	Can. (Used with L503 & L505).
Q205	19A700054P1	Silicon, NPN, 60 w; sim to BD-201.	R406	19A700019P57	Deposited carbon: 47K ohms $\pm 5\%$, 1/4 w.	R625 and R626	19A700019P37	Deposited carbon: 1K ohms $\pm 5\%$, 1/4 w.			----- SOCKETS -----		19A700068P1	Can. (Used with L409 & L501).
Q401	19A702062P1	Silicon, NPN.	R407	19A700019P29	Deposited carbon: 220 ohms $\pm 5\%$, 1/4 w.	R627A	19A700019P29	Deposited carbon: 220 ohms $\pm 5\%$, 1/4 w.	X501	19A702742P1	Crystal socket. (Quantity 2).		19D429826P1	Knob. (R630).
Q402	19A116818P1	N Channel, field effect.	R501	19A700019P53	Deposited carbon: 22K ohms $\pm 5\%$, 1/4 w.	R627B and R628A	19A700019P27	Deposited carbon: 150 ohms $\pm 5\%$, 1/4 w.			----- CRYSTALS -----		19A134753P5	Machine screw. (Used with R630).
Q501	19A116818P1	N Channel, field effect.	R502 and R503	19A700019P54	Deposited carbon: 27K ohms $\pm 5\%$, 1/4 w.	R628B	19A700019P28	Deposited carbon: 180 ohms $\pm 5\%$, 1/4 w.			2nd Oscillator: 45.4675 MHz.		19J706076P1	Washer, tension. (Used with R630).
Q601 and Q602	19A116774P1	Silicon, NPN; sim to Type 2N5210.	R505	19A700019P37	Deposited carbon: 1K ohms $\pm 5\%$, 1/4 w.	R629	19A700019P48	Deposited carbon: 8.2K ohms $\pm 5\%$, 1/4 w.			----- NETWORKS -----		19A134753P2	Washer. (Used with R630).
Q603 thru Q605	19A134749P1	Silicon, PNP; sim to Type 2N5087.	R506	19A700019P48	Deposited carbon: 8.2K ohms $\pm 5\%$, 1/4 w.	R630	19A134753P1	Variable, carbon film: 47K ohms $\pm 20\%$, 0.1 w.	Z501	19B209613P3	Filter, bandpass: 45.0125 ref. freq, 13 KHz bandwidth.		NP280878P1	Nameplate. (POWER).
		----- RESISTORS -----	R507	19A700019P47	Deposited carbon: 6.8K ohms $\pm 5\%$, 1/4 w.	R631	19A700019P29	Deposited carbon: 220 ohms $\pm 5\%$, 1/4 w.	Z502	19A702171P1	Bandpass filter: 455 ± 1.5 kHz; sim to Murata CFU455D2.		19A702364P106	Machine screw, POZIDRIV*: 2-0.4 x 6. (Secures printed board to casting).
R101	19A700106P39	Composition: 100 ohms $\pm 5\%$, 1/4 w.	R508 and R509	19A700019P41	Deposited carbon: 2.2K ohms $\pm 5\%$, 1/4 w.	R632	19A700019P1	Deposited carbon: 1 ohms $\pm 5\%$, 1/4 w.			Printed Wire Board.		19B233285P1	Spring, ground clip. (Located on side of printed board at C404).
R102	19A700106P77	Composition: 3.9K ohms $\pm 5\%$, 1/4 w.	R510	19A700019P33	Deposited carbon: 470 ohms $\pm 5\%$, 1/4 w.	R633	19A700019P40	Deposited carbon: 1.8K ohms $\pm 5\%$, 1/4 w.	A201	19C850856P1			19C850619G1	Casting. (Used with L101-L103 & L107-L109).
R103	19A700106P93	Composition: 18K ohms $\pm 5\%$, 1/4 w.	R511	19A700019P43	Deposited carbon: 3.3K ohms $\pm 5\%$, 1/4 w.	R634	19A700019P13	Deposited carbon: 10 ohms $\pm 5\%$, 1/4 w.			----- CAPACITORS -----			
R104	19A700106P55	Composition: 470 ohms $\pm 5\%$, 1/4 w.	R512 and R513	19A700019P31	Deposited carbon: 330 ohms $\pm 5\%$, 1/4 w.	R635	19A700019P22	Deposited carbon: 56 ohms $\pm 5\%$, 1/4 w.	C208	19A700006P8	Mica: 12 pF $\pm 5\%$, 100 VDCW; sim to Underwood 3HS0020.			
R105	3R152P11J3	Composition: 11K ohms $\pm 5\%$, 1/4 w.	R514	19A700019P39	Deposited carbon: 1.5K ohms $\pm 5\%$, 1/4 w.	R636A	19A700019P25	Deposited carbon: 270 ohms $\pm 5\%$, 1/4 w.	C209	19A700006P11	Mica: 15 pF $\pm 5\%$, 100 VDCW; sim to Underwood 3HS0020.			
R106	19A700106P63	Composition: 1K ohms $\pm 5\%$, 1/4 w.	R515	19A700019P50	Deposited carbon: 12K ohms $\pm 5\%$, 1/4 w.	R636B	19A700019P21	Deposited carbon: 47 ohms $\pm 5\%$, 1/4 w.	C210 and C211	19A700006P17	Mica: 22 pF $\pm 5\%$, 100 VDCW; sim to Underwood 3HS0020.			
R107	19A700106P45	Composition: 180 ohms $\pm 5\%$, 1/4 w.	R516	19A7000019P35	Deposited carbon: 680 ohms $\pm 5\%$, 1/4 w.	R636D	19A700019P17	Deposited carbon: 22 ohms $\pm 5\%$, 1/4 w.			----- TRANSISTORS -----			
R108	19A700106P15	Composition: 10 ohms $\pm 5\%$, 1/4 w.	R517	19A700019P47	Deposited carbon: 6.8K ohms $\pm 5\%$, 1/4 w.	R636E	19A700019P11	Deposited carbon: 6.8 ohms $\pm 5\%$, 1/4 w.	Q201	19A702458P1	Silicon, NPN.			
R109	19A700106P39	Composition: 100 ohms $\pm 5\%$, 1/4 w.	R518	19A700019P48	Deposited carbon: 8.2K ohms $\pm 5\%$, 1/4 w.	R637	19A700019P35	Deposited carbon: 680 ohms $\pm 5\%$, 1/4 w.			----- INTEGRATED CIRCUITS -----			
R110	19A700106P63	Composition: 1K ohms $\pm 5\%$, 1/4 w.	R519	19A700019P39	Deposited carbon: 1.5K ohms $\pm 5\%$, 1/4 w.	R638	19A700018P1	Deposited carbon: 1 ohm $\pm 5\%$, 1/3 w.	U201	19A143904P2	RF Amplifier.			
R111	19A700106P81	Composition: 5.6K ohms $\pm 5\%$, 1/4 w.	R520	19A700019P49	Deposited carbon: 10K ohms $\pm 5\%$, 1/4 w.	R639	19A700019P25	Deposited carbon: 100 ohms $\pm 5\%$, 1/4 w.			800 MHz CHASSIS 19C850620G1, G2			
R112	3R152P511J	Composition: 510 ohms $\pm 5\%$, 1/4 w.	R521	19B800784P209	Variable: 25K ohms $\pm 20\%$, 1/2 w; sim to Murata Type RVG0911V328.	R640A	19A700019P13	Deposited carbon: 10 ohms $\pm 5\%$, 1/4 w.			----- FILTERS -----			
R114	19A700106P39	Composition: 100 ohms $\pm 5\%$, 1/4 w.	R522	19A700019P49	Deposited carbon: 10K ohms $\pm 5\%$, 1/4 w.	R640B	19A700019P41	Deposited carbon: 2.2K ohms $\pm 5\%$, 1/4 w.	FL907	19A703219G1	Capacitor: 2 ceramic feed thrus; 100 pF $\pm 20\%$, 250 VDCW.			
R115	19A700106P73	Composition: 2.7K ohms $\pm 5\%$, 1/4 w.	R523	19A700019P43	Deposited carbon: 3.3K ohms $\pm 5\%$, 1/4 w.	R640C	19A700019P57	Deposited carbon: 47K ohms $\pm 5\%$, 1/4 w.			----- MISCELLANEOUS -----			
R116	3R152P511J	Composition: 510 ohms $\pm 5\%$, 1/4 w.	R524 and R525	19A700019P56	Deposited carbon: 39K ohms $\pm 5\%$, 1/4 w.	R642	19A700019P37	Deposited carbon: 1K ohms $\pm 5\%$, 1/4 w.			Chassis. (Used in 19D900742G3).			
R117	19A700106P23	Composition: 22 ohms $\pm 5\%$, 1/4 w.	R526	19A700019P9	Deposited carbon: 4.7 ohms $\pm 5\%$, 1/4 w.	R645	19A700019P49	Deposited carbon: 10K ohms $\pm 5\%$, 1/4 w.			Chassis. (Used in 19D900742G2).			
R118	3R152P622J	Composition: 6200 ohms $\pm 5\%$, 1/4 w.	R528	19A700019P36	Deposited carbon: 820 ohms $\pm 5\%$, 1/4 w.	R646	19A700019P38	Deposited carbon: 1.2K ohms $\pm 5\%$, 1/4 w.			Screw, thd. forming: No. 3.5-0.6 x 8. (Secures A1 to frame - Quantity 9).			
R119	3R152P511J	Composition: 510 ohms $\pm 5\%$, 1/4 w.	R601	19A700019P57	Deposited carbon: 47K ohms $\pm 5\%$, 1/4 w.	R647	19A700019P52	Deposited carbon: 18K ohms $\pm 5\%$, 1/4 w.			Screw, thd. forming: No. M3.5-0.6 x 25. (Secures A1 to frame - Quantity 1).			
R120	19A700106P47	Composition: 220 ohms $\pm 5\%$, 1/4 w.	R602	19A700019P53	Deposited carbon: 22K ohms $\pm 5\%$, 1/4 w.	R648	19A700019P37	Deposited carbon: 1K ohms $\pm 5\%$, 1/4 w.			Lockwasher, external tooth: M2.5. (Secures Q201).			
R121	19A700106P69	Composition: 1.8K ohms $\pm 5\%$, 1/4 w.	R603	19A700019P31	Deposited carbon: 330 ohms $\pm 5\%$, 1/4 w.			----- SWITCHES -----			Lockwasher, internal tooth: No. 3.5MM. (Secures U201).			
R122	19A700113P23	Composition: 22 ohms $\pm 5\%$, 1/2 w.	R604	19A700019P52	Deposited carbon: 18K ohms $\pm 5\%$, 1/4 w.	S602	19B800563P1	Push: DPDT, 1 station, alternate action; sim to IEEE/SCHADOW 51281 (P2UEE).			Tab. (Solders to A1).			
R123	19A700106P63	Composition: 1K ohms $\pm 5\%$, 1/4 w.	R605	19A700019P49	Deposited carbon: 10K ohms $\pm 5\%$, 1/4 w.			----- TEST POINTS -----			Shield. (Located at C125, C127, C133, C134).			
R124	19A700106P15	Composition: 10 ohms $\pm 5\%$, 1/4 w.	R606	19A700019P49	Deposited carbon: 10K ohms $\pm 5\%$, 1/4 w.	TP101	19A700152P1	Contact. (Quantity 1 each).			Support. (Used with Q205, U601, U602).			
R201	19A700106P15	Composition: 10 ohms $\pm 5\%$, 1/4 w.	R607	19B800784P208	Variable: 10K ohms $\pm 20\%$, 1/2 w; sim to Murata Type RVG0911V328.	TP103					Insulator, plate. (Used with Q205 & U602).			
R202	19A700106P35	Composition: 68 ohms $\pm 5\%$, 1/4 w.	R608	19A700019P47	Deposited carbon: 6.8K ohms $\pm 5\%$, 1/4 w.	TP401	19A700152P1	Contact. (Quantity 2 each).			Insulator, bushing. (Used with Q205 & U602).			
R203	19A700016P3	Variable, cermet: 4.7K ohms $\pm 10\%$, 1/2 w.	R609	19A701828P2	Thermistor: 470 pF $\pm 20\%$; sim to Philips 2322-642-61471.	TP501					Machine screw, metric: 2.5-.45 x 10MM. (Secures Q205, U601, U602).			
R204	19A700019P35	Deposited carbon: 680 ohms $\pm 5\%$, 1/4 w.	R610	19A700019P48	Deposited carbon: 8.2K ohms $\pm 5\%$, 1/4 w.			----- INTEGRATED CIRCUITS -----						
R205	19A700019P37	Deposited carbon: 1K ohms $\pm 5\%$, 1/4 w.	R611	19A700019P26	Deposited carbon: 120 ohms $\pm 5\%$, 1/4 w.	U101	19B209680P1	Mixer, balanced.						
R206	19A700019P47	Deposited carbon: 6.8K ohms $\pm 5\%$, 1/4 w.	R612	19A700019P33	Deposited carbon: 470 ohms $\pm 5\%$, 1/4 w.	U501	19A134759P1	Linear, Dual Differential Amplifier, 14 Pin Dip.						
R207	19A700019P35	Deposited carbon: 680 ohms $\pm 5\%$, 1/4 w.	R613	19A700019P36	Deposited carbon: 820 ohms $\pm 5\%$, 1/4 w.	U502	19A134766P1	Linear, Outline For 16-Pin Dip case.						
R208	19A700019P29	Deposited carbon: 220 ohms $\pm 5\%$, 1/4 w.	R614	19A700019P44	Deposited carbon: 3.9K ohms $\pm 5\%$, 1/4 w.	U601	19A134769P2	Linear: sim to TDA 2002.						
R209	19A700019P40	Deposited carbon: 1.8K ohms $\pm 5\%$, 1/4 w.	R615	19A700019P57	Deposited carbon: 47K ohms $\pm 5\%$, 1/4 w.	U602	19A138414G1	Regulator: 8.5 V.						
R210	19A700019P34	Deposited carbon: 560 ohms $\pm 5\%$, 1/4 w.	R616	19A700019P49	Deposited carbon: 10K ohms $\pm 5\%$, 1/4 w.			----- CABLES -----						
R211	19A700106P35	Composition: 68 ohms $\pm 5\%$, 1/4 w.				W101 thru W103		Part of printed board.						
R212	19A700016P3	Variable, cermet: 4.7K ohms $\pm 10\%$, 1/2 w.												

PRODUCTION CHANGES

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter," which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

REV. A - Transmit/Receive Board 19D900623G2, 3

To eliminate possibility of solder bridges and shorts. Delete T101 and C111. Added L118. T101 was: 19A701767G1 Transformer. C111 was: 19A700219P10 Ceramic: 2.2 pF $\pm 5\%$, 100 VDCW, temp. coef 0 PPM. C112 was: 19A700219P48 Ceramic: 36 pF $\pm 5\%$, 100 VDCW, temp. coef 0 PPM.

REV. B - To improve PA operation at low temperatures. Changed C205. C205 was: 19A701225P1, Electrolytic: 15 μ F $\pm 75\%$, 63 VDCW; sim to Sprague 501D156-G025BB1C.

REV. C - To improve low end audio response (300 Hertz). Changed C607 from 10 Nanofarads to 15 Nanofarads. Old Part Number for C607 was: C607, 19A700234P7 Polyester: 0.01 μ F $\pm 10\%$, 50 VDCW.

REV. D - To improve operation of Receive Audio Circuit. Changed R647. Old Part Number was: C647, 19A700019P54 - Deposited Carbon: 27K ohms $\pm 5\%$, 1/4 w.

REV. E - To improve operation of power control circuit. Changed C220. The old Part Number was: C220, 19A701534P4 - Tantalum: 1 μ F $\pm 20\%$, 35 VDCW.

REV. F - To improve decoupling of Power Control Circuit from vehicle battery and improve reliability of Q204. Changed C222 and added R215 in the 13 volt line between C222(+) and Q205-C. Break the printed wire run between the above and solder in R215. Old Part Number is: C222, 19A701534P4 - Tantalum: 1 μ F $\pm 20\%$, 35 VDCW.